HIGH VOLTAGE SURFACE MOUNT DUAL SWITCHING DIODE

Features

- Fast Switching Speed: Maximum of 50ns
- High Reverse Breakdown Voltage: 300V
- Low Leakage Current: Maximum of 100nA when V_R = 240V at Room Temperature
- Surface Mount Package Ideally Suited for Automated Insertion
- For General Purpose Switching Applications
- **Qualified to AEC-Q101 Standards for High Reliability**
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

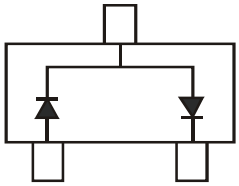
Mechanical Data

- Case: SOT323
- Case Material: Molded Plastic, "Green" Molding Compound, UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish - Matte Tin annealed over Copper leadframe. (Lead Free Plating) Solderable per MIL-STD-202, Method 208 e3
- Polarity: See Diagram
- Weight: 0.006 grams (approximate)

SOT323



Top View



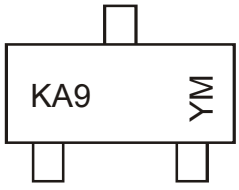
Top View
Internal Schematic

Ordering Information (Notes 4 & 5)

Part Number	Compliance	Case	Packaging
MMBD2004SW-7-F	Standard	SOT323	3000/Tape & Reel
MMBD2004SWQ-7-F	Automotive	SOT323	3000/Tape & Reel

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at http://www.diodes.com.
5. Product manufactured with Date Code 0627 (week 27, 2006) and newer are built with Green Molding Compound. Product manufactured prior to Date Code 0627 are built with Non-Green Molding Compound and may contain Halogens or Sb2O3 Fire Retardants.

Marking Information



KA9= Product Type Marking Code
YM = Date Code Marking
Y = Year (ex: B = 2014)
M = Month (ex: 9 = September)

Date Code Key

Year	2003	2004	…..	2013	2014	2015	2016	2017	2018	2019
Code	P	R	…..	A	B	C	D	E	F	G

Month	Jan	Feb	Mar	Apr	May	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	O	N	D

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Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Repetitive Peak Reverse Voltage	V_{RRM}	300	V
Working Peak Reverse Voltage DC Blocking Voltage	V_{RWM} V_R	240	V
RMS Reverse Voltage	$V_{R(RMS)}$	170	V
Forward Continuous Current	I_F	225	mA
Peak Repetitive Forward Current	I_{FRM}	625	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0μs @ t = 1.0s	I_{FSM}	4.0 1.0	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 6)	P_D	250	mW
Thermal Resistance Junction to Ambient Air (Note 6)	$R_{\theta JA}$	500	°C/W
Operating and Storage Temperature Range	T_J , T_{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 7)	$V_{(BR)R}$	300	—	V	I_R = 100μA
Forward Voltage	V_F	— —	0.87 1.0	V	I_F = 20mA I_F = 100mA
Peak Reverse Current (Note 7)	I_R	— —	100	nA μA	V_R = 240V V_R = 240V, T_J = +150°C
Total Capacitance, per Element	C_T	—	5.0	pF	V_R = 0, f = 1.0MHz
Reverse Recovery Time	t_{rr}	—	50	ns	I_F = I_R = 30mA, I_{rr} = 3.0mA, R_L = 100Ω

Notes: 6. Part mounted on FR-4 PC Board with recommended pad layout, which can be found on our website at http://www.diodes.com.
7. Short duration pulse test used to minimize self-heating effect.

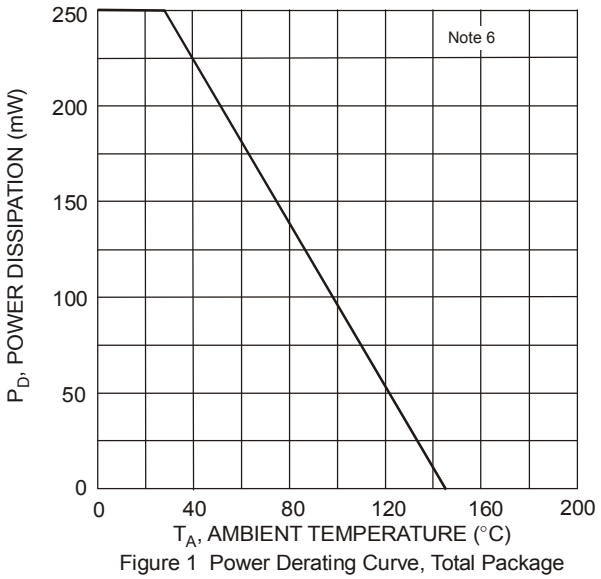

Figure 1 Power Derating Curve, Total Package

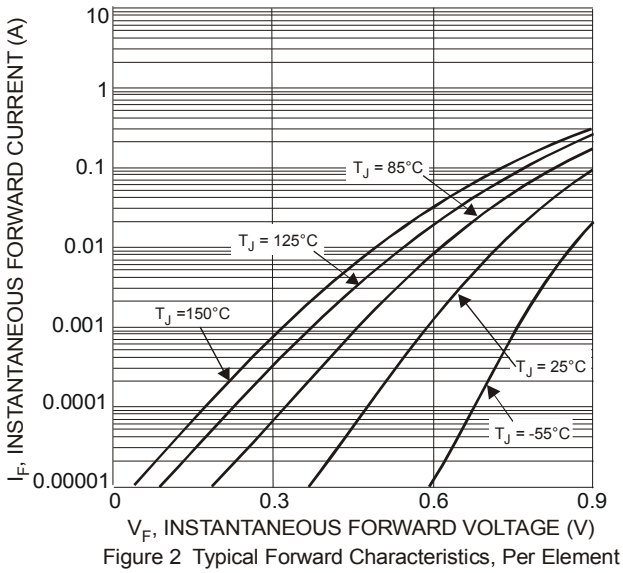

Figure 2 Typical Forward Characteristics, Per Element

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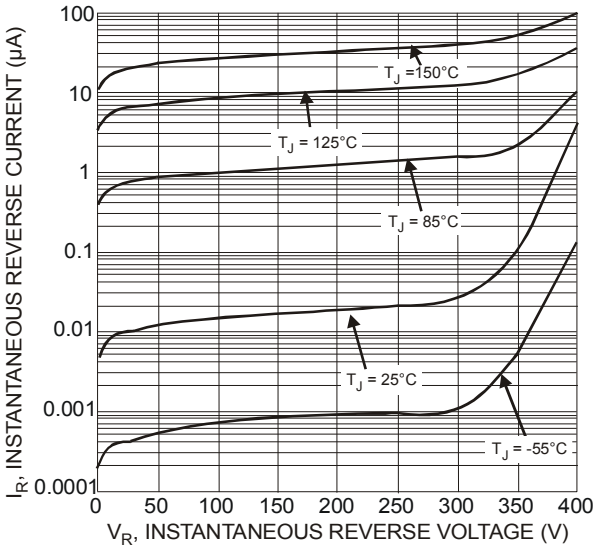


Figure 3 Typical Reverse Characteristics, Per Element

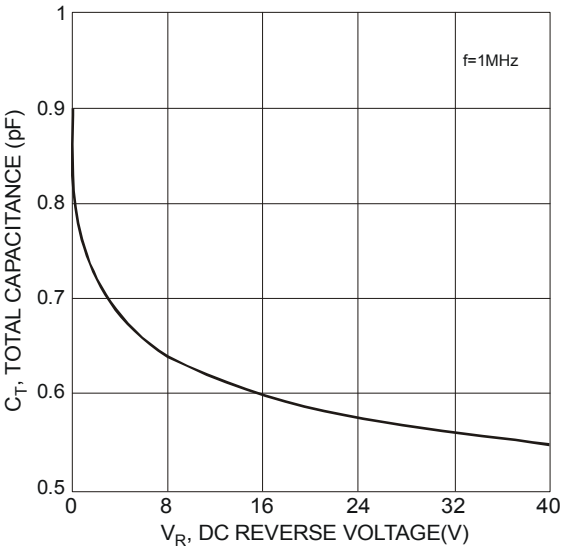
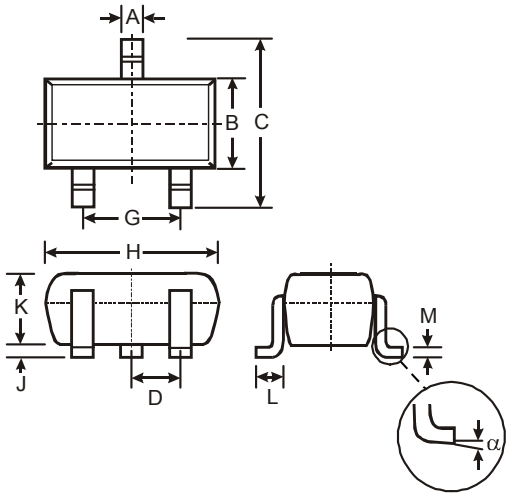


Figure 4 Total Capacitance vs. Reverse Voltage, Per Element

Package Outline Dimensions

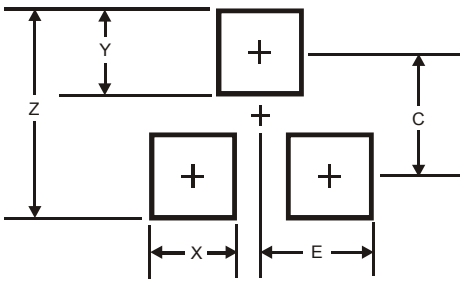
Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



SOT323			
Dim	**Min**	**Max**	**Typ**
A	0.25	0.40	0.30
B	1.15	1.35	1.30
C	2.00	2.20	2.10
D	-	-	0.65
G	1.20	1.40	1.30
H	1.80	2.20	2.15
J	0.0	0.10	0.05
K	0.90	1.00	1.00
L	0.25	0.40	0.30
M	0.10	0.18	0.11
α	0°	8°	-
All Dimensions in mm			

Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value (in mm)
Z	2.8
X	0.7
Y	0.9
C	1.9
E	1.0

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